

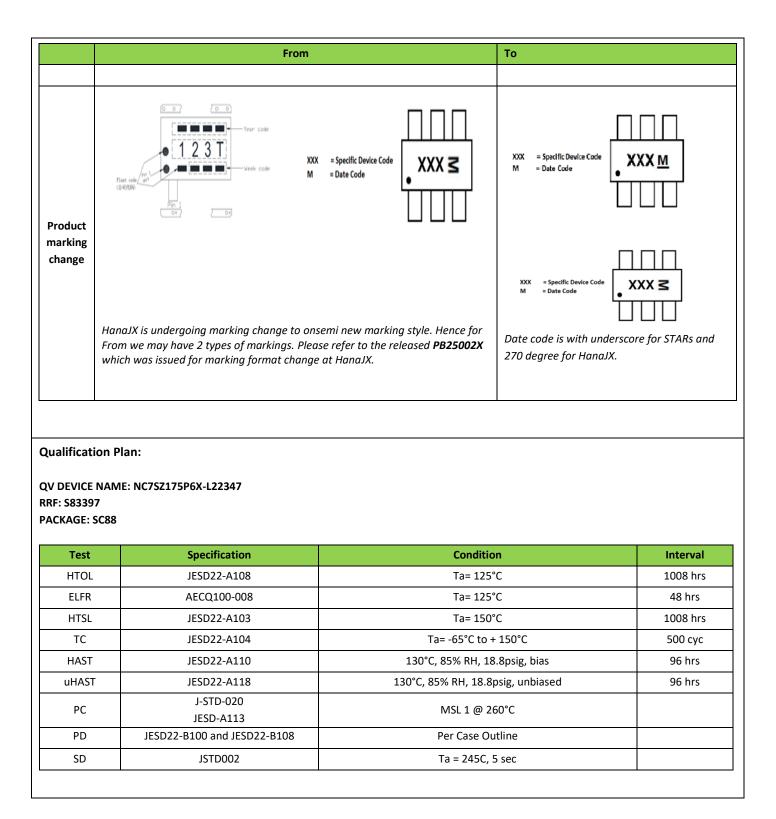
Initial Product/Process Change Notification Document #: IPCN25003X Issue Date: 09 Nov 2022

Title of Change:	NC7SZ175P6X-L22347 A	NC7SZ175P6X-L22347 Assembly and Test Site Addition (SC88).					
Proposed First Ship date:	03 Apr 2023 or earlier if	03 Apr 2023 or earlier if approved by customer					
Contact Information:	Contact your local onse	Contact your local onsemi Sales Office or <u>logic.fpcn@onsemi.com</u>					
PCN Samples Contact:	Sample requests are to Initial PCN or Final PCN, Samples delivery timing	Contact your local onsemi Sales Office. Sample requests are to be submitted no later than 30 days from the date of first notification, Initial PCN or Final PCN, for this change. Samples delivery timing will be subject to request date, sample quantity and special customer packing/label requirements.					
Type of Notification:	advance notification ab change details and devi The completed qualif Product/Process Chang Product/Process Chang	This is an Initial Product/Process Change Notification (IPCN) sent to customers. An IPCN is an advance notification about an upcoming change and contains general information regarding the change details and devices affected. It also contains the preliminary reliability qualification plan. The completed qualification and characterization data will be included in the Final Product/Process Change Notification (FPCN). This IPCN notification will be followed by a Final Product/Process Change Notification (FPCN) at least 90 days prior to implementation of the change. In case of questions, contact < <u>PCN.Support@onsemi.com</u> >					
Marking of Parts/ Traceability of Change:	New plant site is with n	New plant site is with new onsemi marking style with underscore below the date code.					
Change Category:	marking change, Test Cl	marking change, Test Change, Assembly Change					
Change Sub-Category(s):	Shipping/Packaging/Ma	Shipping/Packaging/Marking					
Sites Affected:							
onsemi Sites None		External Foundry/Subcon Sites					
		HANA Microelectronics, China					
		STARS Microelectronics, Thailand					
Description and Purpose: A new Subcon site was qualified to incre	ase back-end capacity. There i	is no chang		the marking of plant code.			
	FION		То				
Assembly Site	Hana		Hana	STARs			
LeadFrame	LF SC88 6L 70X86	PPF	LF SC88 6L 70X86 PPF	LF SC70 6L D28X37 PPF			
LeadFrame Die Attach	LF SC88 6L 70X86 DA EPOXY ABLESTICK		LF SC88 6L 70X86 PPF DA EPOXY ABLESTICK 2200D	LF SC70 6L D28X37 PPF CONDUCTIVE EPOXY 8390			

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List of Affected Parts:

Note: Only the standard (off the shelf) part numbers are listed in the parts list. Any custom parts affected by this PCN are shown in the customer specific PCN addendum in the PCN email notification, or on the **PCN Customized Portal**.

Part Number	Qualification Vehicle
NC7SZ175P6X-L22347	NC7SZ175P6X-L22347

Appendix A: Changed Products

DIKG: DIGI-KEY

Product	Customer Part Number	Qualification Vehicle	New Part Number	Replacement Supplier
NC7SZ175P6X-L22347		NC7SZ175P6X-L22347	NA	